



PONNI SUGARS (ERODE) LIMITED

CIN : L15422 TN1996 PLC037200

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Investor Grievance ID: investor@ponnisugars.com



PEL / SH / 110

18th September 2026

National Stock Exchange of India Ltd
Exchange Plaza
5th Floor, Flat No.C/ 1 G Block
Bandra-Kurla Complex
Bandra East, Mumbai 400 051

BSE Ltd
Phiroze Jeejeebhoy Towers
Dalal Street,
Fort
Mumbai 400001

Scrip code: PONNIERODE

Scrip code: 532460

Sir/Madam,

Sub: Newspaper publication regarding opening of special window for transfer and dematerialization of Physical Securities.

Pursuant to SEBI circular No. SEBI/HO/38/13/11(2)2026-MIRSD-PoD/I/3750/2026 dated 30th January 2026, we enclose herewith the copy of newspaper publication in Business Standard on 18.09.2026 regarding opening of special one-year window from **5th February 2026 to 4th February 2027** for transfer and dematerialisation ("demat") of physical securities which were sold/purchased prior to April 01, 2019.

Kindly take the same on your records.

Thanking you,

Yours Faithfully

For Ponni Sugars (Erode) Limited

R Madhusudhan
Company Secretary & Compliance Officer

Encl: As above

quick scroll

Huawei to launch two new AI semiconductors in 2027

Huawei Technologies will launch two new artificial-intelligence (AI) semiconductors in 2027, rotating chairman David Wang said on Thursday, as it builds up its AI computing business and seeks to challenge US chipmaker Nvidia. Huawei plans to launch the 960DT in the first quarter of 2027 and the Ascend 960PR in the third quarter, Wang said. It is also working on ways to connect very large numbers of AI chips, allowing them to work together as one bigger computing system. Most advanced AI programmes require more processing power than a single chip can provide.

HCLTech launches new business unit for mid-sized companies

HCLTech has launched HCLTech Pulse, a dedicated business unit focused on helping enterprises with annual revenues between \$500 million and \$5 billion, to safely scale up AI and modernise their technology foundations, HCLTech Pulse is designed for organisations with enterprise-scale ambitions that have historically had to stitch together niche providers across strategy, platforms, implementation and operations. It helps clients move beyond isolated AI initiatives by connecting AI strategy, data, cyber, platforms, engineering and business-process transformation into a single, integrated transformation agenda.

Biggest opportunity lies in making AI operational across enterprises: Coforge CEO

AVIK DAS Bengaluru, 17 September Coforge chief executive officer (CEO) and executive director Sudhir Singh said information technology (IT) services companies have the opportunity to bridge the gap between artificial intelligence (AI) adoption and operationalising it within enterprises even as the technology puts pressure on the traditional businesses. "The industry needs to find the next wave of value creation and adopting and operationalising AI is the single biggest opportunity," he said at an analyst event on Thursday. "The industry is at an inflection point, world class AI is not downloadable and it is

Semicon giants see India pull up a seat at global chip table

Fabs, advanced packaging, power electronics emerge as key growth areas

UDISHA SRIVASTAV New Delhi, 17 September

India's push to build a domestic semiconductor industry is drawing interest from global chip companies, whose representatives highlighted the country's manufacturing ambitions, engineering talent, and expanding technology ecosystem as opportunities for the global chip industry. Speaking at Semicon India, being held from September 17 to 19 in New Delhi, the executives pointed to artificial intelligence (AI), data centres, power electronics, advanced packaging, and fabrication (fab) as areas where the country could play a larger role in the global semiconductor supply chain. Wayne Allan, chief strategic sourcing and procurement officer at ASML, estimated that India's semiconductor market could reach \$110-120 billion by 2030, while stressing that meeting the country's localisation ambitions would require



Prime Minister Narendra Modi greets a gathering at Semicon India 2026, in New Delhi on Thursday

multiple fabs and a much broader supporting ecosystem. For ASML, the immediate opportunity is tied to Tata Electronics' planned 300-millimetre (12-inch) semiconductor fab in Dholera, Gujarat, for which a strategic partnership was announced in May this year. "We're here to support that and make sure that Tata is successful, so many more fabs will be built in India. We believe that there's a huge opportunity for India to be a big part of this growth and also to take its place as a semiconductor powerhouse," Allan said. ASML expects Tata's facility to be operational around 2028. Highlighting confidence in India's ambitions and progress in the semiconductor sector, Jochen Hanebeck, chief executive officer of Infineon Technologies, said the rapid expansion of data centres was creating demand not only for computing chips but also for technologies that generate, transmit, store,

and efficiently deliver electricity. In his keynote address, Hanebeck pointed to opportunities in renewable energy, battery storage, solid-state transformers, high-voltage direct current systems, and power conversion inside data centres. "There is no compute without power, and we take care from grid to core." Meanwhile, Srinivasan Iyengar, senior vice-president and general manager of Intel's central engineering group, said the company had operated in India for more than four decades and saw the country's engineering talent and startup ecosystem as important components of its future growth. "The most important thing is a trusted partnership. With India at the forefront, and India going from what I would call good to great, that part of the journey is amazing, propelling through the vision of semiconductor makers and making semiconductors the new buzzword," Iyengar said.

Tata Electronics chips in with global, Indian players

UDISHA SRIVASTAV New Delhi, 17 September

Tata Electronics on Thursday announced a series of strategic partnerships with global semiconductor companies and Indian institutions. These partnerships range from materials and wafer manufacturing to advanced packaging, chip design, supply-chain localisation, and workforce development. The memoranda of understanding signed on the sidelines of Semicon India 2026, include collaborations with Nexperia, Fujifilm Holdings Corporation, BE Semiconductor Industries

(Besi), Semi-Conductor Laboratory (SCL), and Gati Shakti Vishwavidyalaya. Under its partnership with Nexperia, Tata Electronics will collaborate across front-end wafer fabrication (fab), back-end assembly and test, and technology and ecosystem development. As part of the front-end collaboration, the companies are laying the groundwork for manufacturing Nexperia's MOSFET (metallic oxide semiconductor) field-effect transistor portfolio at Tata Electronics' upcoming 300-millimetre/mm

(12-inch) semiconductor fab in Dholera, Gujarat. The Nexperia-Tata Electronics partnership will also cover the assembly and testing of Nexperia's discrete semiconductor products at Tata Electronics' semiconductor packaging facility in Jagiroad, Assam. Separately, Tata Electronics has signed an MoU with Fujifilm to accelerate the development of the country's semiconductor material ecosystem. Under the agreement, Fujifilm will use its global expertise to develop and supply advanced semiconductor

materials tailored to the requirements of Tata Electronics' upcoming Dholera fab. Fujifilm also plans to invest roughly ₹800 crore (around \$83 million) in phases to establish a semiconductor material plant in the Dholera Special Investment Region. In the packaging domain, Tata Electronics has entered into an MoU with Dutch semiconductor assembly solutions provider Besi to strengthen advanced packaging capabilities in India. Tata Electronics is investing \$3 billion in its Jagiroad facility. Under the collaboration, the firm will leverage Besi's advanced packaging equipment and technologies. Tata Electronics has signed an MoU with SCL for strategic cooperation aimed at advancing semiconductor indigenisation.

India important hub for semicon manufacturing, says Meity secretary

UDISHA SRIVASTAV New Delhi, 17 September



India is one of the significant countries for semiconductor manufacturing and design, said S. Krishnan, secretary of the Ministry of Electronics and Information Technology (MeitY), on Thursday. While delivering a keynote address on the inaugural day of Semicon India 2026, Krishnan said, "We have truly arrived in the semiconductor space and we are at a position where India is one of the important countries for the future of semiconductor manufacture, in addition to being one of the (significant) countries for semiconductor design." Krishnan added that India is also emerging as a major market for semiconductors. "Given the size of India's population, we are truly at an inflection stage in terms of potential and possible consumption expenditures. You will see that consumption of a lot of electronic products using semiconductor chips is bound to go up. For a country this size, it cannot afford to be entirely dependent on manufacturing something as vital as semiconductors." Highlighting the concerns

S. Krishnan, secretary of the Ministry of Electronics and Information Technology arising from the geopolitical crisis, Krishnan said, "Diversification of global value chains and building resilience is today as much an objective for anybody in the world as is making sure that you get products at competitive prices. One of the essential elements of competitiveness today is also resilience." On the need for collaboration within the ecosystem, Krishnan said the Centre is closely working with all the states in the country, which are potentially places where the investments can take place. "Many of them have also promised that they will be in a position to provide at least about 50 per cent of what the government of India provides as its assistance, incentive for establishing (semicon) facilities."

KAS group seeks govt support for R&D

Semiconductor equipment makers need greater government support for research and development (R&D), including incentives for developing tools, locally, said senior executive from KAS Technologies at Semicon India 2026. "There are certain actions that can be further supported by the government like there should be more equipment R&D incentives that should be executed," said Kunal Singh Bisht, manager, equipment development, at KAS Technologies.

Industry leaders flag need for process, product engineers

Industry representatives highlighted the need for an experienced talent pool in the country's semiconductor ecosystem while discussing the push towards advanced packaging at Semicon 2026 in New Delhi. Speaking at a roundtable on advanced packaging, industry representatives cited sustained reliance on imported engineers and the need to improve the nation's STEM education even as they acknowledged India's lead in design engineers.



ADITYA BIRLA FASHION AND RETAIL LIMITED

Registered Office: Piramal Agastya Corporate Park, Building 'A', 4th and 5th Floor, Unit No. 401, 403, 501, 502, L.B.S. Road, Kurla, Mumbai - 400 070; CIN: L18101MH2007PLC233901 | Website: www.abfrl.com Email: secretarial@abfrl.adityabirla.com | Tel.: +91-86529-05000

SPECIAL WINDOW FOR RE-LODGE

Securities and Exchange Board of India ("SEBI") had discontinued transfer of physical shares from April 1, 2019. However, a special window was opened by SEBI from July 7, 2025 to January 6, 2026, for re-lodgement of physical share transfer requests originally submitted before April 1, 2019 but returned due to deficiencies in documentation.

In order to facilitate the Investors, the SEBI vide its Circular No. HO/38/13/11(2)/2026-MIRSD-POD/3750/2026 dated January 30, 2026 has decided to open another special window for period of one year from February 5, 2026 to February 4, 2027. While lodging request under special window for transfer of physical shares, one of the mandatory requirements is submission of original share certificate which is as follows:

Execution Date of Transfer Deed	Lodged for transfer before April 01, 2019	Original Security Certificate Available?	Eligible to lodge in the current window?
Before April 1, 2019	No (It is fresh lodgement)	Yes	✓
	Yes (It was rejected / returned earlier)	Yes	✓
	Yes	No	✗
	No	No	✗

Further, the following cases shall not be considered under the aforesaid special window:

- Cases involving disputes between transferor and transferee.
- Securities which have been transferred to Investor Education and Protection Fund (IEPF).

Important Note: All shares re-lodged during this period shall be processed through the transfer cum demat route. Accordingly, the securities shall be issued only in dematerialised (demat) form after transfer and shall be subject to a lock in period of one year from the date of dematerialisation.

Shareholders who had missed the earlier deadline for re-lodgement of transfer deeds are encouraged to take advantage of this opportunity by submitting the requisite documents to the Company's Registrar and Share Transfer Agent ("RTA"), details of which are provided below. In case of any clarification, shareholders may contact the Company or the RTA at the addresses mentioned herein:

Aditya Birla Fashion and Retail Limited	MUFG Intime India Private Limited
Piramal Agastya Corporate Park, Building 'A', 4 th and 5 th Floor, Unit No. 401, 403, 501, 502, L.B.S. Road, Kurla, Mumbai - 400 070 Email: secretarial@abfrl.adityabirla.com Website: www.abfrl.com	C-101, Embassy 247, L.B.S. Marg, Vikhroli (West), Mumbai - 400083 Email: investor.helpdesk@in.mfgms.mufg.com Website: https://in.mfgms.mufg.com

Update of KYC and Dematerialisation of Physical Shares:

Shareholders holding securities in physical form are advised to update their KYC details and convert their physical shareholdings into dematerialised (electronic) form. Holding securities in dematerialised form offers several advantages and eliminates the risks associated with physical share certificates.

For Aditya Birla Fashion and Retail Limited
Sd/-
Rajeev Agrawal
Company Secretary & Compliance Officer
ACS 18877

Date: September 18, 2026
Place: Mumbai

An Aditya Birla Group Company

APPOINTMENTS

राष्ट्रीय प्रौद्योगिकी संस्थान अगरतला
NATIONAL INSTITUTE OF TECHNOLOGY AGARTALA
Barjala, Jirania, Agartala – 799 046 (Tripura)

No. F.NITA.2(519-Estt)/2019/Vol-III/4473 Date: 10.09.2026
RECRUITMENT FOR NON-TEACHING POSTS

National Institute of Technology (NIT) Agartala invites applications from eligible Indian Citizens possessing consistently good academic record and requisite qualifications and experience for recruitment to various Non Teaching Posts (Gr-B & Gr-C) on Direct recruitment basis under the Pay Level of 7th CPC . Interested candidates may apply online through the link available on the Institute website at <https://nita.ac.in> under the tab Recruitment. The link for online application shall remain active from 10:00 AM on 20th September, 2026 to 20th October, 2026 (till 05 PM only). For further details please visit Institute Website at <https://nita.ac.in>.

Registrar

PONNI SUGARS (ERODE) LIMITED
CIN: L15422 TN 1996 PLC 037200
Regd. Office: "ESVIN House", 13, Rajiv Gandhi Salai (OMR), Perungudi, Chennai-600 096
Phone: 044-24961920, 24960156 Email: admin@ponnisugars.com
Investor Grievance ID: investor@ponnisugars.com Web: www.ponnisugars.com

SPECIAL WINDOW FOR TRANSFER AND DEMATERIALIZATION OF PHYSICAL SHARES

Pursuant to SEBI circular No. SEBI/HO/38/13/11(2)/2026-MIRSD-POD/3750/2026 dated 30th January 2026, investors are informed that, a special one-year window from 5th February 2026 to 4th February 2027 is opened for transfer and dematerialisation ("demat") of physical securities which were sold/purchased prior to April 01, 2019. The details can be accessed by scanning the QR code.

For Ponni Sugars (Erode) Limited
R Madhusudan
Company Secretary & Compliance Officer

Chennai
17-09-2026

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SUNDARAM MUTUAL
— Sundaram Finance Group —

Notice – cum – Addendum to the Scheme Information Document / Key Information Memorandum / Statement of Additional Information to the schemes of Sundaram Mutual Fund ('Fund')

Resumption of Official Point of Acceptance of Transaction (OPAC) of Sundaram Mutual Fund

Unitholders and investors are requested to note that the Official Point of Acceptance of Transactions (OPAC) of Sundaram Mutual Fund, located at "Sundaram Towers, 1st & 2nd Floor, No. 46, Whites Road, Royapettah, Chennai – 600014", which was earlier declared non-functional on January 23, 2026 due to administrative/maintenance reasons, will now resume operations with effect from September 21, 2026 (Effective Date).

Accordingly, investors may submit their physical transactions at the above-mentioned OPAC from effective date.

All other terms and conditions of the Scheme Information Document(s) / Key Information Memorandum(s) / Statement of Additional Information will remain unchanged.

This addendum forms an integral part of the Scheme Information Document (SID) / Key Information Memorandum (KIM) / Statement of Additional Information (SAI) of the Schemes of Sundaram Mutual Fund as amended from time to time.

For Sundaram Asset Management Company Ltd
R Ajith Kumar
Company Secretary & Compliance Officer

Place: Chennai
Date: September 18, 2026.

For more information please contact:
Sundaram Asset Management Company Ltd
(Investment Manager to Sundaram Mutual Fund)
CIN: U93090TN1996PLC034615

Corporate Office: 1st & 2nd Floor, Sundaram Towers, 46, Whites Road, Royapettah, Chennai-14.
Contact No. (India) 1860 425 7237, (NRI) +91 40 2345 2215
www.sundarammutual.com
Regd. Office: No. 21, Patullus Road, Chennai 600 002.

Mutual Fund Investments are subject to market risks, read all scheme related documents carefully.